

### Features

- Precision Monitor of(2.5V/3.0V/3.3V/5.0V) power supply voltage
- Full specified over temperature
- Manual reset input
- Available in four output configuration
- Push-pull  $\overline{\text{RESET}}$  Active low(APX811)
- Push-pull  $\text{RESET}$  Active high(APX812)
- Power-on reset generator with fixed delay time 200ms
- SOT143: Available in "Green" Molding Compound (No Br, Sb)
- Lead Free Finish/RoHS Compliant (Note 1)

### General Description

The APX811/812 are used for microprocessor supervisory circuit to monitor the power supplies in These circuit perform a single function: they assert a reset signal whenever the Vcc supply voltage declines below a preset threshold, keeping it asserted for at least 240ms after Vcc has risen above the reset threshold. Reset thresholds suitable for operation with a variety of supply voltages are available. The APX811/812 have push-pull outputs. The APX811 has an active low  $\overline{\text{RESET}}$  output, while the APX812 has an active high  $\text{RESET}$  output.

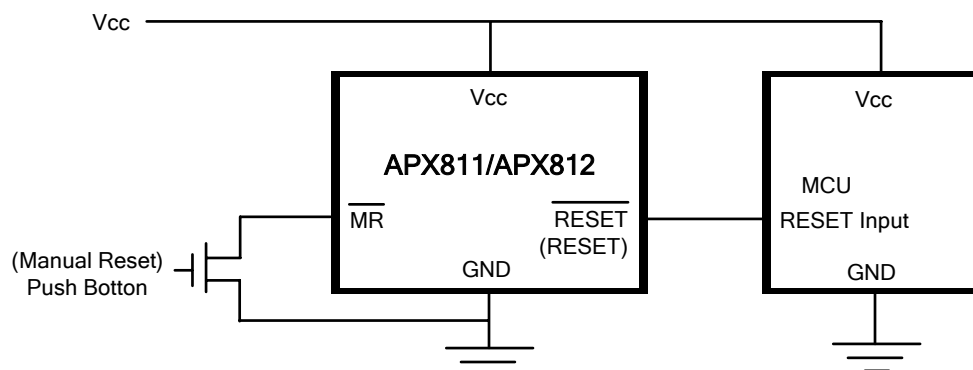
The APX811/812 devices incorporate a manual reset input,  $\overline{\text{MR}}$ . A low level at  $\overline{\text{MR}}$  causes RESET to become active.

The APX811/2 are targeted at 2.5V, 3V, 3.3V and 5V powered systems and are available with different threshold voltages to meet the exact needs of the system. They are available in the space saving SOT143 package and operate over the whole industrial temperature range, -40 to 85°C.

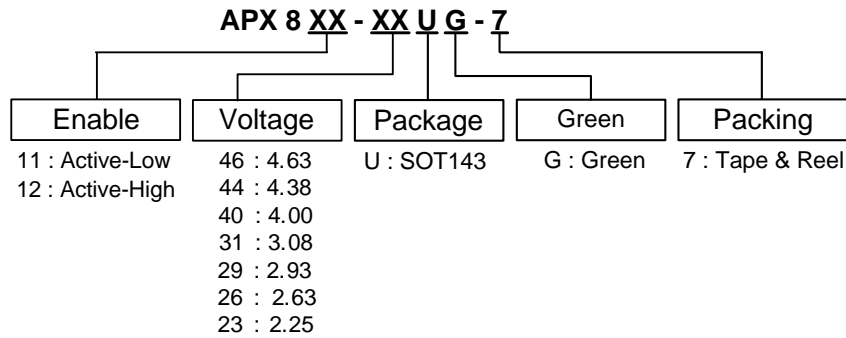
### Applications



- Computers
- Controllers
- Intelligent Instruments
- Critical uP and UC power Monitoring
- Portable/Battery powered Equipment
- Automotive

### Typical Application Circuit



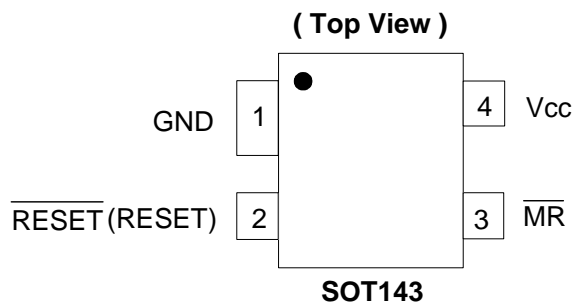
### Ordering Information



Device	Package Code	Packaging (Note 2)	7" Tape and Reel	
			Quantity	Part Number Suffix
 APX811-XXUG-7	U	SOT143	3000/Tape & Reel	-7
 APX812-XXUG-7	U	SOT143	3000/Tape & Reel	-7

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at [http://www.diodes.com/products/lead\\_free.html](http://www.diodes.com/products/lead_free.html).  
 2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

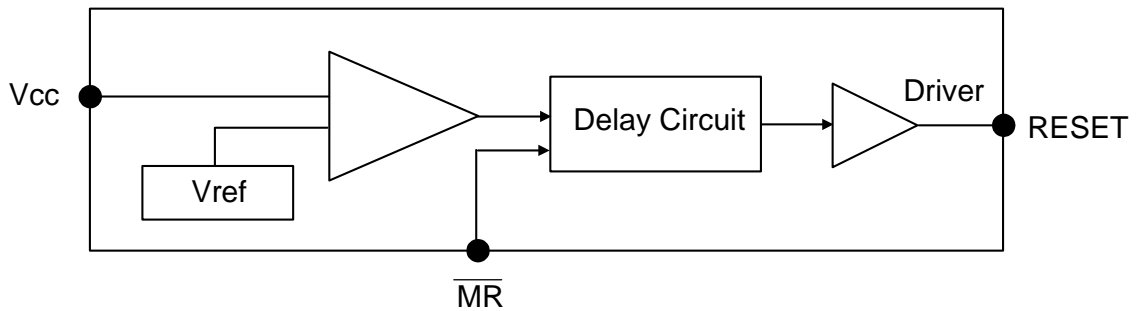
### Pin Assignments



### Pin Descriptions

Pin Name	Description
GND	Ground
$\overline{\text{RESET}}$ (RESET)	Reset output Pin L: for APX811 H: for APX812
VCC	Operating Voltage Input
$\overline{\text{MR}}$	Manual reset (Active Low)

### Block Diagram



### Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD protection	3	kV
ESD MM	Machine Model ESD Protection	500	V
$V_{CC}$	Supply voltage	-0.3~7	V
$V_{RESET}$	RESET	-0.3 to ( $V_{CC}+0.3$ )	V
$I_{CC}$	Input Current, $V_{CC}$	20	mA
$I_O$	Output current	20	mA
$P_D$	Power dissipation	320	mW

### Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
$V_{CC}$	Supply Voltage	1.1	5.5	V
$V_{IN}$	Input Voltage	0	( $V_{CC}+0.3$ )	V
$T_A$	Operating Ambient Temperature	-40	85	°C

### Electrical Characteristics (T<sub>A</sub> = 25°C)

T<sub>A</sub> = -40 to 85 °C unless otherwise note. Typical values are at T<sub>A</sub> = +25 °C.

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
V <sub>CC</sub>	V <sub>CC</sub> Range		1.0		5.5	V
I <sub>CC</sub>	Supply Current	V <sub>th</sub> + 0.2V		30	40	μA
V <sub>th</sub>	Reset threshold	T <sub>A</sub> = 25 °C.	2.22	2.25	2.28	V
			2.59	2.63	2.67	V
			2.89	2.93	2.98	V
			3.03	3.08	3.13	V
			3.94	4.00	4.06	V
			4.31	4.38	4.45	V
			4.56	4.63	4.70	V
t <sub>s</sub>	Set-up Time	V <sub>CC</sub> = V <sub>th</sub> to (V <sub>th</sub> - 100mV)		20		μs
V <sub>OL</sub>	RESET <sub>̄</sub> Output Voltage Low (APX811)	V <sub>CC</sub> = V <sub>th</sub> - 0.2, I <sub>SINK</sub> = 1.2mA			0.3	V
		V <sub>CC</sub> = V <sub>th</sub> - 0.2, I <sub>SINK</sub> = 3.2mA			0.4	
		V <sub>CC</sub> > 1.0V, I <sub>SINK</sub> = 50uA			0.3	
V <sub>OH</sub>	RESET <sub>̄</sub> Output Voltage-High (APX811)	V <sub>CC</sub> > V <sub>th</sub> + 0.2, I <sub>SOURCE</sub> = 500uA	0.8V <sub>CC</sub>			V
		V <sub>CC</sub> > V <sub>th</sub> + 0.2, I <sub>SOURCE</sub> = 800uA	V <sub>CC</sub> - 1.5			
V <sub>OL</sub>	RESET Output Voltage-Low (APX812)	V <sub>CC</sub> = V <sub>th</sub> + 0.2, I <sub>SINK</sub> = 1.2mA			0.3	V
		V <sub>CC</sub> = V <sub>th</sub> + 0.2, I <sub>SINK</sub> = 3.2mA			0.4	
V <sub>OH</sub>	RESET Output Voltage-High (APX812)	1.8V < V <sub>CC</sub> < V <sub>th</sub> - 0.2, I <sub>SOURCE</sub> = 150uA	0.8 V <sub>CC</sub>			V
θ <sub>JA</sub>	Thermal Resistance Junction-to-Ambient	SOT143 (Note 3)		240		°C/W
θ <sub>JC</sub>	Thermal Resistance Junction-to-Case	SOT143 (Note 3)		71		°C/W

Notes: 3. Test condition for SOT143: Device mounted on FR-4 substrate, 1"×1", 2oz, copper, single-sided, PC boards.

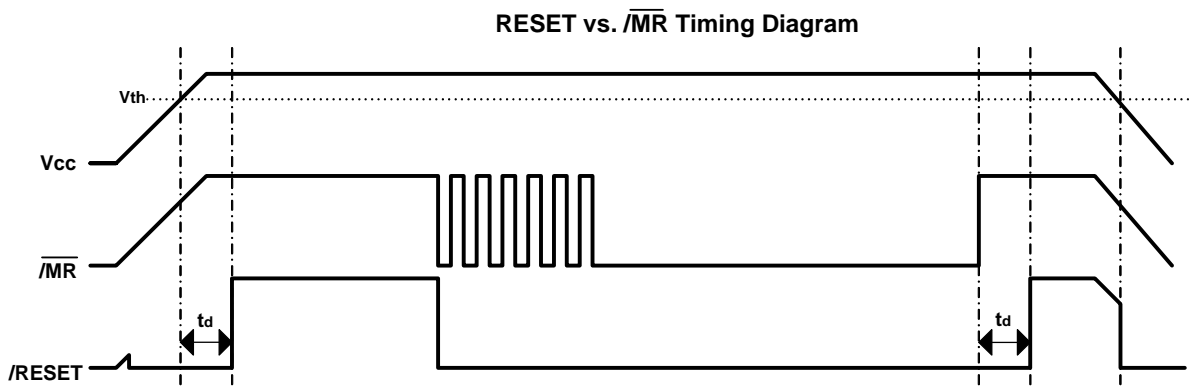
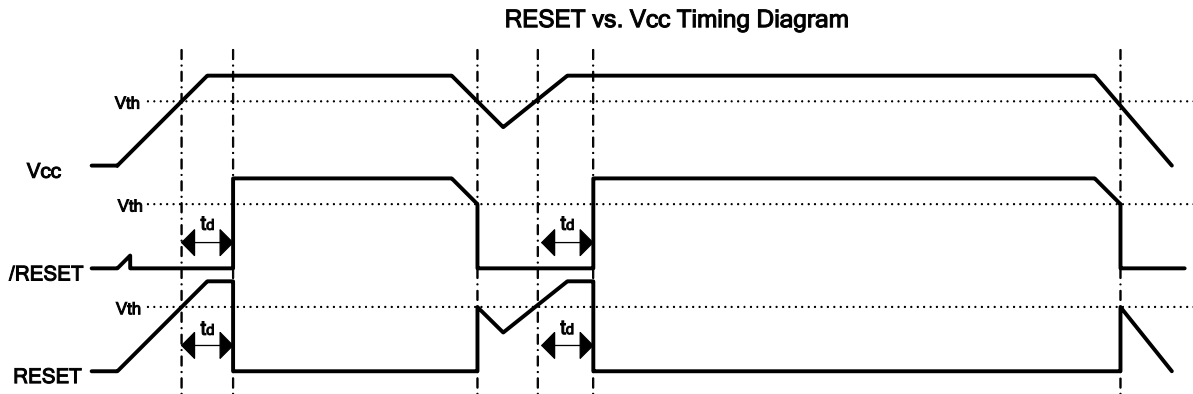
### Timing requirements (T<sub>A</sub> = 25°C)

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
t <sub>w</sub>	Pulse Width at MR	V <sub>CC</sub> > V <sub>th</sub> + 0.2V, V <sub>IL</sub> = 0.3 × V <sub>CC</sub> , V <sub>IH</sub> = 0.7 × V <sub>CC</sub>	100	-	-	ns

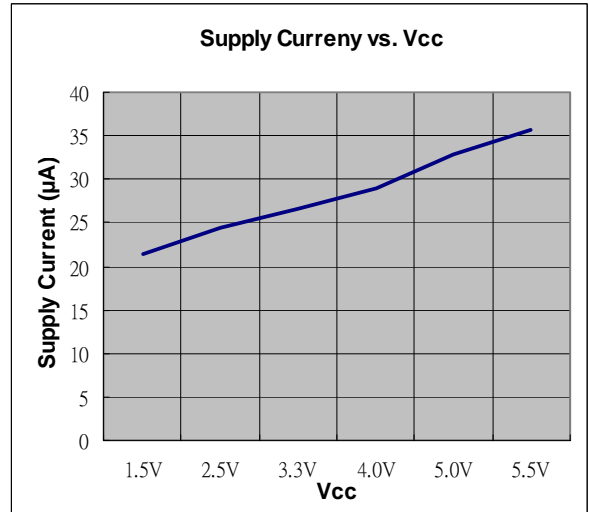
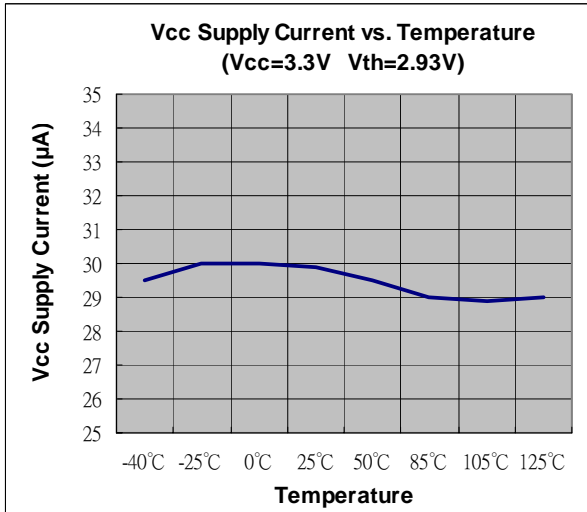
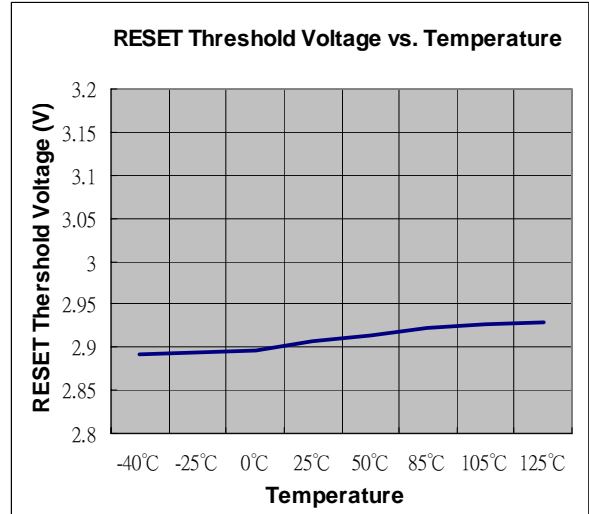
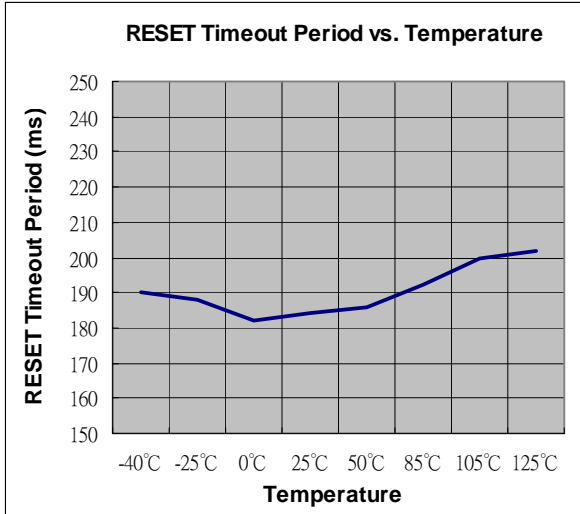
### Switching Characteristics (T<sub>A</sub>=25°C)

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
t <sub>d</sub>	Delay Time	APX811/812 V <sub>CC</sub> > V <sub>th</sub> +0.2V, See timing diagram	140	200	280	ms
t <sub>PHL</sub>	Propagation (Delay) Time, High-to-low-level Output	$\overline{\text{MR}}$ to RESET delay (APX811/812) V <sub>CC</sub> > V <sub>th</sub> +0.2V, V <sub>IL</sub> =0.3×V <sub>CC</sub> , V <sub>IH</sub> =0.7×V <sub>CC</sub>	-	-	0.1	μs
		V <sub>CC</sub> to $\overline{\text{RESET}}$ delay V <sub>IL</sub> = V <sub>th</sub> -0.2V, V <sub>IH</sub> = V <sub>th</sub> +0.2V	-	-	25	μs
t <sub>PLH</sub>	Propagation (Delay) Time, Low-to-high-level Output	$\overline{\text{MR}}$ to RESET delay (APX811/812) V <sub>CC</sub> > V <sub>th</sub> +0.2V, V <sub>IL</sub> =0.3×V <sub>CC</sub> , V <sub>IH</sub> =0.7×V <sub>CC</sub>	-	-	0.1	μs
		V <sub>CC</sub> to RESET delay (APX811/812) V <sub>IL</sub> = V <sub>th</sub> -0.2V, V <sub>IH</sub> = V <sub>th</sub> +0.2V	-	-	25	μs

### Timing Diagram



**Typical Performance Characteristics**



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### Application Information

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A microprocessor's ( $\mu\text{P}$ 's) reset input starts the  $\mu\text{P}$  in a known state. The APX811/812 asserts reset to prevent code-execution errors during power-up, power-down, or brownout conditions. They assert a reset signal whenever the  $V_{\text{CC}}$  supply voltage declines below a preset threshold or the  $\overline{\text{MR}}$  pin is brought low, keeping it asserted for at least 240ms after  $V_{\text{CC}}$  has risen above the reset threshold. The APX811/812 have a push-pull output stage.

The APX811/812 reset output is guaranteed to be logic low for the APX811 and high the APX812 for  $V_{\text{CC}} > 1\text{V}$ . Once  $V_{\text{CC}}$  exceeds the reset threshold, an internal timer keeps  $\overline{\text{RESET}}$  output low (and RESET high for the APX812) for the reset timeout period. After this interval, the APX811's  $\overline{\text{RESET}}$  output goes high (APX812's RESET output goes low). If a brownout condition occurs ( $V_{\text{CC}}$  dips below the reset threshold), the APX811's  $\overline{\text{RESET}}$  output goes low (APX812's RESET output goes high). Any time  $V_{\text{CC}}$  goes below the reset threshold, the internal timer resets to zero, and  $\overline{\text{RESET}}$  goes low (RESET goes high). The internal timer starts after  $V_{\text{CC}}$  returns above the reset threshold, and  $\overline{\text{RESET}}$  remains low (RESET remains high) for the reset timeout period.

#### Ensuring a Valid Reset Output Down to $V_{\text{CC}} = 0$

When  $V_{\text{CC}}$  falls below 1V, the APX811  $\overline{\text{RESET}}$  no longer sinks current—it becomes an open circuit. Therefore, high-impedance CMOS logic inputs connected to  $\overline{\text{RESET}}$  can drift to undetermined voltages. This presents no problem in most applications since most  $\mu\text{P}$  and other circuitry is inoperative with  $V_{\text{CC}}$  below 1V. However, in applications where  $\overline{\text{RESET}}$  must be valid down to 0V, adding a pull down resistor to  $\overline{\text{RESET}}$  causes any stray leakage currents to flow to ground, holding  $\overline{\text{RESET}}$  low. R1's value is not critical; 100k is large enough not to load  $\overline{\text{RESET}}$  and small enough to pull  $\overline{\text{RESET}}$  to ground.

For the APX812 if RESET is required to remain valid for  $V_{\text{CC}} < 1\text{V}$  then a 100k $\Omega$  pull-up resistor between RESET and  $V_{\text{CC}}$  is recommended.

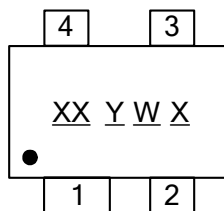
#### Benefits of Highly Accurate Reset Threshold

Most  $\mu\text{P}$  supervisor ICs has reset threshold voltages between 5% and 10% below the value of nominal supply voltages. This ensures a reset will not occur within 5% of the nominal supply, but will occur when the supply is 10% below nominal. When using ICs rated at only the nominal supply  $\pm 5\%$ , this leaves a zone of uncertainty where the supply is between 5% and 10% low, and where the reset may or may not be asserted.

### Marking Information

(1) SOT143

( Top View )



XX : Identification code

Y : Year 0~9

W : Week : A~Z : 1~26 week;  
a~z : 27~52 week; z represents  
52 and 53 week

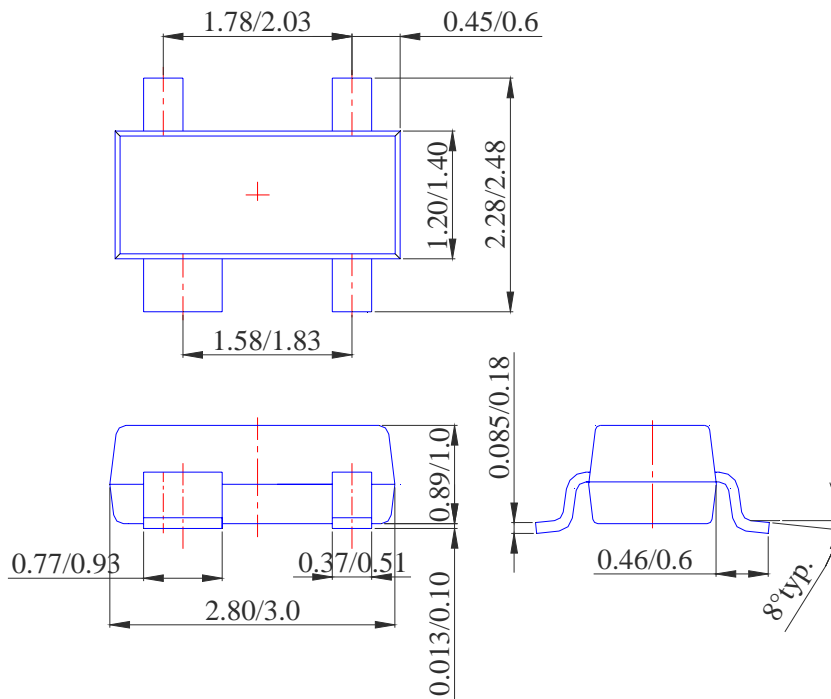
X : A~Z : Green

Device	Package	Identification Code
APX811-46U	SOT143	C2
APX811-44U	SOT143	C3
APX811-40U	SOT143	C4
APX811-31U	SOT143	C5
APX811-29U	SOT143	C6
APX811-26U	SOT143	C7
APX811-23U	SOT143	C8
APX812-46U	SOT143	C9
APX812-44U	SOT143	CA
APX812-40U	SOT143	CB
APX812-31U	SOT143	CC
APX812-29U	SOT143	CD
APX812-26U	SOT143	CE
APX812-23U	SOT143	CF



**Package Information** (All Dimensions in mm)

(1) Package Type: SOT143



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